650 V, 20.6 A, 190 m Ω

FCH190N65F-F085

Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SUPERFET II is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV–EV automotive.

SUPERFET II, FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- Typ. $R_{DS(on)} = 148 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 10 \text{ A}$
- Typ. $Q_{g(tot)} = 63 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 10 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

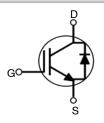
- Automotive On Board Charger
- Automotive DC/DC Converter for HEV



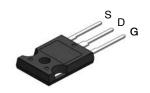
ON Semiconductor®

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V _{DS}	R _{DS(ON)} MAX	I _D MAX
650 V	190 mΩ @ 10 V	20.6 A

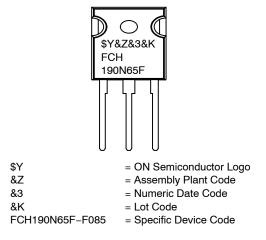


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain to Source Voltage	650	V
V _{GSS}	Gate to Source Voltage	±20	V
I _D	Drain Current – Continuous (V _{GS} = 10) (Note 1)	20.6	А
	Pulsed Drain Current	See Fig. 4	А
E _{AS}	Single Pulsed Avalanche Rating (Note 2)	400	mJ
dv/dt	MOSFET dv/dt	100	V/ns
	Peak Diode Recovery dv/dt (Note 3)	50	
PD	Power Dissipation	208	W
	Derate Above 25°C	1.67	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to + 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Current is limited by bondwire configuration.

2. Starting $T_J = 25 \text{ °C}$, L = 50 mH, $I_{AS} = 4 \text{ A}$, $V_{DD} = 100 \text{ V}$ during inductor charging and $V_{DD} = 0 \text{ V}$ during time in avalanche. 3. $I_{SD} \le 10 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le 380 \text{ V}$, Starting $T_J = 25 \text{ °C}$.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH190N65F	FCH190N65F-F085	TO-247-3	-	-	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ hetaJC}$	R _{0JC} Thermal Resistance, Junction to Case, Max.		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

4. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

OFF CHARACTERISTICS								
50 μA, V _{GS} = 0 V	650	-	-	V				
650 V, $T_J = 25 \ ^{\circ}C$	-	-	10	μA				
T _J = 150 °C (Note 5)	-	-	1	mA				
±20 V	-	-	±100	nA				
($\begin{array}{c} \text{650 V,} \\ \text{0 V} \\ \end{array} \begin{array}{c} \text{T}_{\text{J}} = 25 \ ^{\circ}\text{C} \\ \text{T}_{\text{J}} = 150 \ ^{\circ}\text{C} \ (\text{Note 5}) \end{array}$	$\begin{array}{c} 650 \text{ V,} \\ 0 \text{ V} \\ T_{\text{J}} = 25 \text{ °C} \\ T_{\text{J}} = 150 \text{ °C} \text{ (Note 5)} \\ \end{array}$	$\begin{array}{c} 650 \text{ V,} \\ 0 \text{ V} \\ \hline \text{T}_{\text{J}} = 25 \text{ °C} \\ \hline \text{T}_{\text{J}} = 150 \text{ °C} \text{ (Note 5)} \\ \hline \text{-} \\ \hline \end{array}$	$ \begin{array}{c} 650 \text{ V,} \\ 0 \text{ V} \end{array} \begin{array}{c} T_{\text{J}} = 25 \text{ °C} & - & - & 10 \\ T_{\text{J}} = 150 \text{ °C} \text{ (Note 5)} & - & - & 1 \end{array} $				

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		3	-	5	V
R _{DS(on)}	Drain to Source On Resistance	$I_{\rm D} = 27 {\rm A}$	T _J = 25 °C	-	148	190	mΩ
		V _{GS} = 10 V	T _J = 150 °C (Note 5)	-	346	401	mΩ

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	2447	3181	pF
C _{oss}	Output Capacitance		-	2345	3048	pF
C _{rss}	Reverse Transfer Capacitance		-	131	-	pF
Rg	Gate Resistance	f = 1 MHz	-	0.5	-	Ω
Q _{g(tot)}	Total Gate Charge	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 10 \text{ A}, V_{GS} = 10 \text{ V}$	-	63	82	nC
Q _{g(th)}	Threshold Gate Charge	$v_{GS} = 10 v$	-	4.3	5.6	nC
Q _{gs}	Gate to Source Gate Charge		-	12.6	-	nC
Q _{gd}	Gate to Drain "Miller"Charge		-	28	_	nC

SWITCHING CHARACTERISTICS

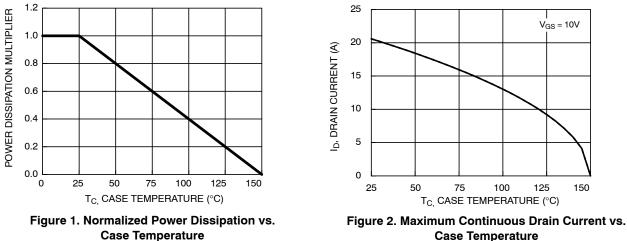
t _{on}	Turn–On Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 10 \text{ A},$	-	40	100	ns
t _{d(on)}	Turn-On Delay Time	V_{GS} = 10 V, R_{G} = 4.7 Ω	-	25	-	ns
t _r	Rise Time		-	14.5	-	ns
t _{d(off)}	Turn-Off Delay Time		-	64	-	ns
t _f	Fall Time		-	5	-	ns
t _{off}	Turn–Off Time		-	69	158	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

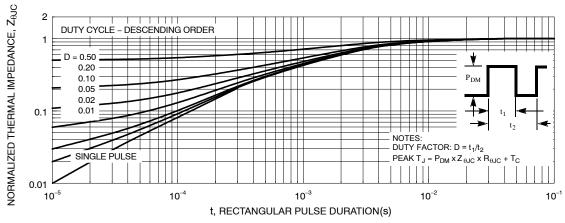
	V_{SD}	Source to Drain Diode Voltage	V_{GS} = 0 V, I _{SD} = 10 A	-	-	1.2	V
	t _{rr}	Reverse Recovery Time	$V_{DD} = 520 \text{ V}, \text{ I}_{\text{F}} = 10 \text{ A},$	-	141	-	ns
ĺ	Q _{rr}	Reverse Recovery Charge	dl _{SD} /dt = 100 A/μs	-	889	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. The maximum value is specified by design at $T_J = 150^{\circ}$ C. Product is not tested to this condition in production.

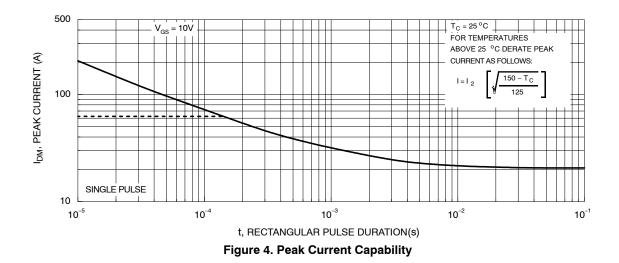
TYPICAL CHARACTERISTICS



Case Temperature







TYPICAL CHARACTERISTICS

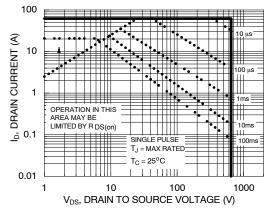


Figure 5. Forward Bias Safe Operating Area

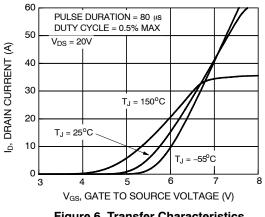


Figure 6. Transfer Characteristics

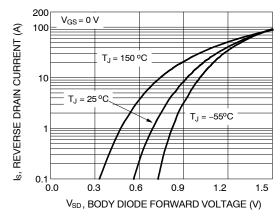
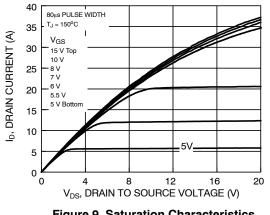


Figure 7. Forward Diode Characteristics





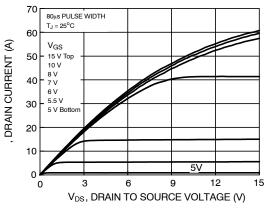
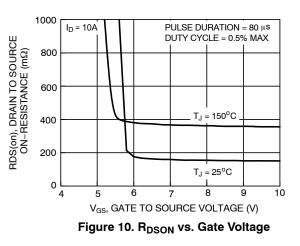
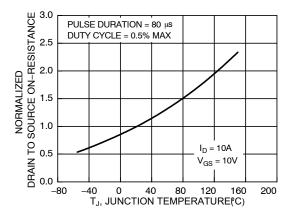


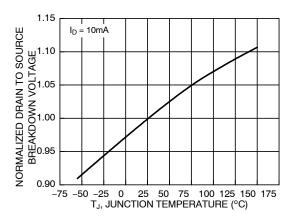
Figure 8. Saturation Characteristics



TYPICAL CHARACTERISTICS









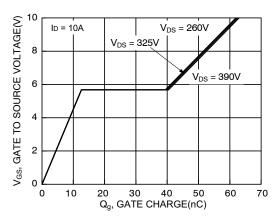


Figure 15. Gate Charge vs. Gate to Source Voltage

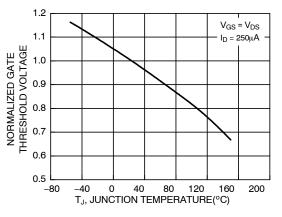


Figure 12. Normalized Gate Threshold Voltage vs. Temperature

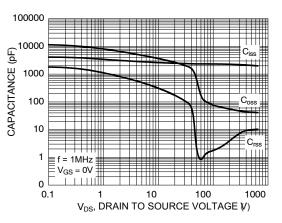


Figure 14. Capacitance vs. Drain to Source Voltage

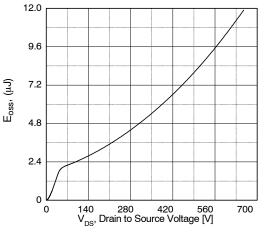
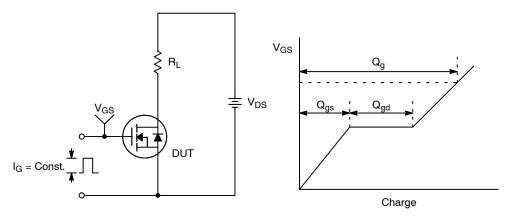


Figure 16. Eoss vs. Drain to Source Voltage





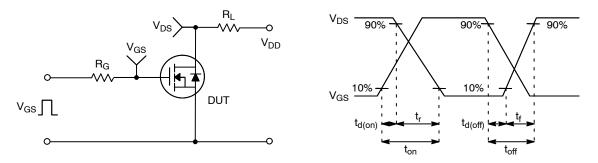


Figure 18. Resistive Switching Test Circuit & Waveforms

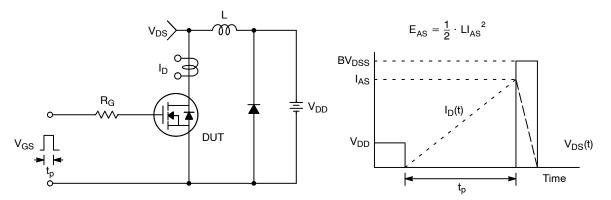


Figure 19. Unclamped Inductive Switching Test Circuit & Waveforms

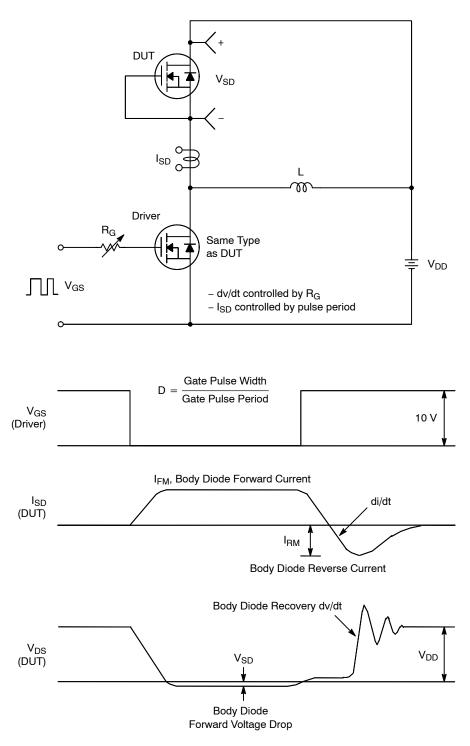


Figure 20. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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